



ALPHA & OMEGA
SEMICONDUCTOR

AOTF380A60CL/AOT380A60CL/AOB380A60CL
600V α MOS5™ N-Channel Power Transistor

General Description

- Proprietary α MOS5™ technology
- Low $R_{DS(ON)}$
- Optimized switching parameters for better EMI performance
- Enhanced body diode for robustness and fast reverse recovery

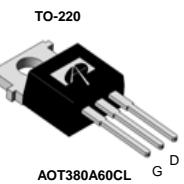
Applications

- SMPS with PFC, Flyback and LLC topologies
- Silver ATX ,adapter, TV, lighting, Server power

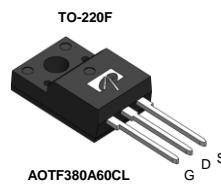
Product Summary

V_{DS} @ $T_{j,max}$	700V
I_{DM}	44A
$R_{DS(ON),max}$	< 0.38Ω
$Q_{g,typ}$	20nC
E_{oss} @ 400V	2.6μJ

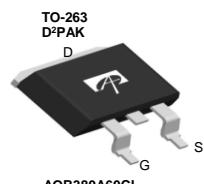
100% UIS Tested
100% R_g Tested



TO-220

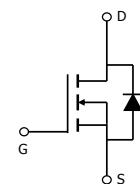


TO-220F



TO-263

DPAK



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOT380A60CL	TO-220 Green	Tube	1000
AOTF380A60CL	TO-220F Green	Tube	1000
AOB380A60CL	TO263	Tape and reel	800

Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOT(B)380A60CL	AOTF380A60CL	Units
Drain-Source Voltage	V_{DS}	600		V
Gate-Source Voltage	V_{GS}	± 20		V
Gate-Source Voltage (dynamic) AC($f>1\text{Hz}$)	V_{GS}	± 30		V
$T_C=25^\circ\text{C}$	I_D	11	11*	A
$T_C=100^\circ\text{C}$		7.2	7.2*	
Pulsed Drain Current ^C	I_{DM}	44		
Avalanche Current ^C	I_{AR}	2.5		A
Repetitive avalanche energy ^C	E_{AR}	3.1		mJ
Single pulsed avalanche energy ^G ($T_J=25^\circ\text{C}$, $V_{GS}=10\text{V}$, $I_L=2\text{Apk}$, $L=105\text{mH}$, $R_{GS}=25\Omega$)	E_{AS}	210		mJ
MOSFET dv/dt ruggedness	dv/dt	100		V/ns
Peak diode recovery dv/dt		20		
$T_C=25^\circ\text{C}$	P_D	131	27	W
Derate above 25°C		1.0	0.2	
Junction and Storage Temperature Range	T_J , T_{ST}	-55 to 150		°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	T_L	300		°C

Thermal Characteristics

Parameter	Symbol	AOT(B)380A60CL	AOTF380A60CL	Units
Maximum Junction-to-Ambient ^{A,D}	R_{iJA}	65	65	°C/W
Maximum Case-to-sink ^A	R_{iCS}	0.5	--	°C/W
Maximum Junction-to-Case	R_{iJC}	0.95	4.6	°C/W

* Drain current limited by maximum junction temperature.

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V, T _J =25°C	600	-	-	V
		I _D =250μA, V _{GS} =0V, T _J =150°C	-	700	-	
BV _{DSS} /ΔT _J	Breakdown Voltage Temperature Coefficient	I _D =250μA, V _{GS} =0V	-	0.44	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =600V, V _{GS} =0V	-	-	1	μA
		V _{DS} =480V, T _J =125°C	-	-	10	
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =5V, I _D =250μA	2.6	3.2	3.8	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =5.5A	-	0.33	0.38	Ω
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =5.5A	-	10	-	S
V _{SD}	Diode Forward Voltage	I _S =5.5A, V _{GS} =0V	-	0.85	1.2	V
I _S	Maximum Body-Diode Continuous Current		-	-	11	A
I _{SM}	Maximum Body-Diode Pulsed Current ^C		-	-	44	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz	-	955	-	pF
C _{oss}	Output Capacitance		-	29	-	pF
C _{o(er)}	Effective output capacitance, energy related ^H	V _{GS} =0V, V _{DS} =0 to 480V, f=1MHz	-	30	-	pF
C _{o(tr)}	Effective output capacitance, time related ^I		-	122	-	pF
C _{rss}	Reverse Transfer Capacitance		-	2.4	-	pF
R _g	Gate resistance	f=1MHz	-	4.8	-	Ω
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =480V, I _D =5.5A	-	20	-	nC
Q _{gs}	Gate Source Charge		-	4.6	-	nC
Q _{gd}	Gate Drain Charge		-	6.6	-	nC
t _{D(on)}	Turn-On DelayTime	V _{GS} =10V, V _{DS} =400V, I _D =5.5A, R _G =5Ω	-	20	-	ns
t _r	Turn-On Rise Time		-	13	-	ns
t _{D(off)}	Turn-Off DelayTime		-	43	-	ns
t _f	Turn-Off Fall Time		-	16	-	ns
t _{rr}	Body Diode Reverse Recovery Time		-	251	-	ns
I _{rm}	Peak Reverse Recovery Current	I _F =5.5A, dI/dt=100A/μs, V _{DS} =400V	-	19	-	A
Q _{rr}	Body Diode Reverse Recovery Charge		-	3.1	-	μC

A. The value of R_{0JA} is measured with the device in a still air environment with T_A=25° C.

B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C, Ratings are based on low frequency and duty cycles to keep initial T_J=25° C.

D. The R_{0JA} is the sum of the thermal impedance from junction to case R_{0JC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

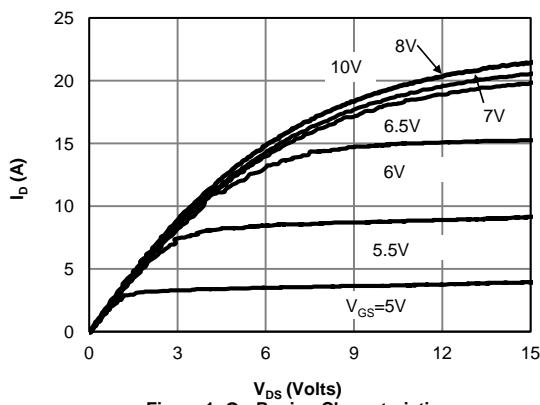
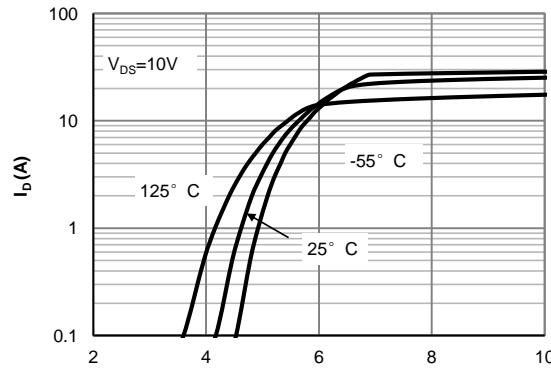
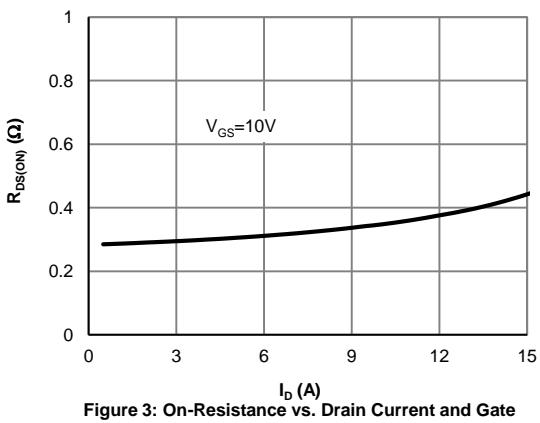
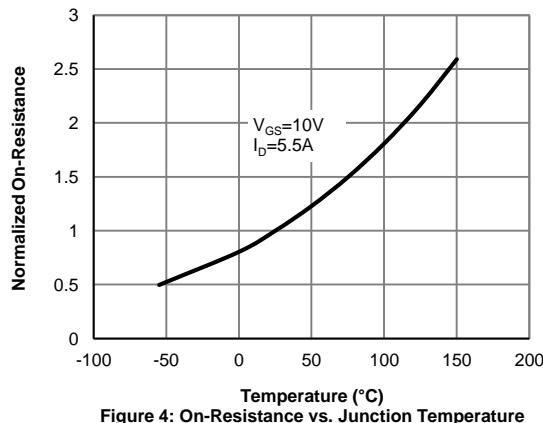
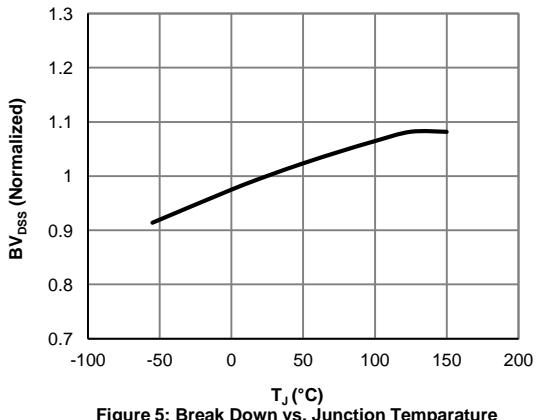
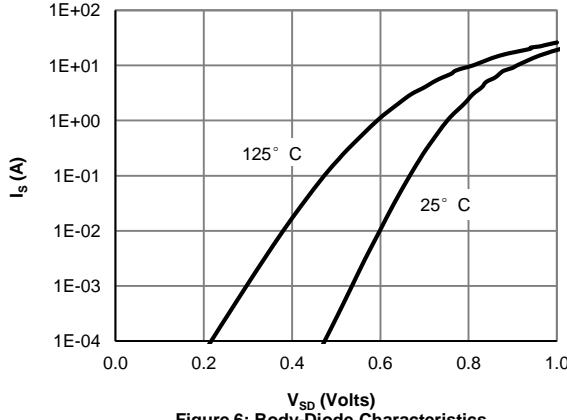
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink k, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

G. This is the absolute maximum rating. Parts are 100% tested at T_J=25° C, L=60mH, I_{AS}=1A, V_{DD}=150V, R_G=25Ω.

H. C_{o(er)} is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

I. C_{o(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 1: On-Region Characteristics

Figure 2: Transfer Characteristics

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature

Figure 5: Break Down vs. Junction Temperature

Figure 6: Body-Diode Characteristics

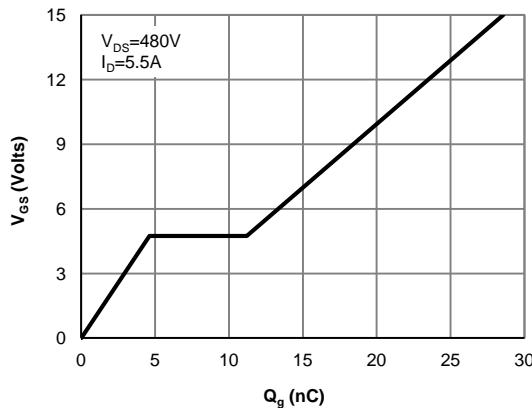
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure 7: Gate-Charge Characteristics

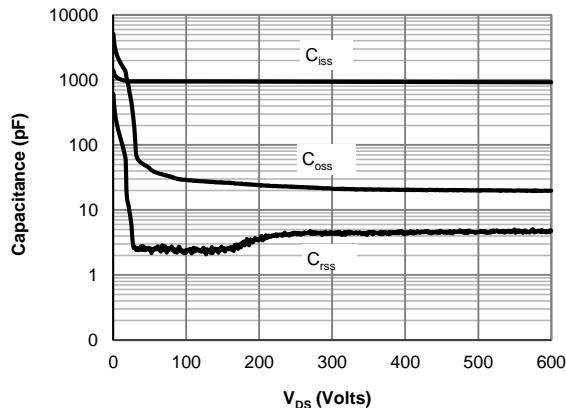
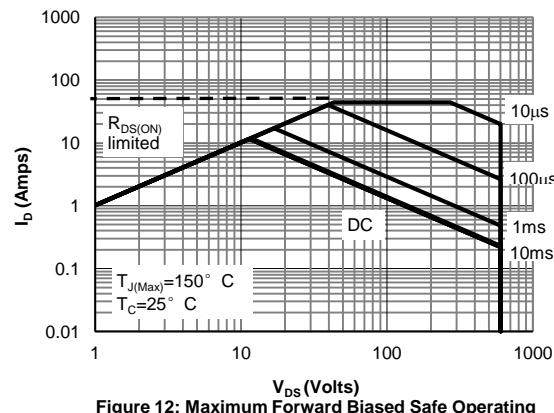
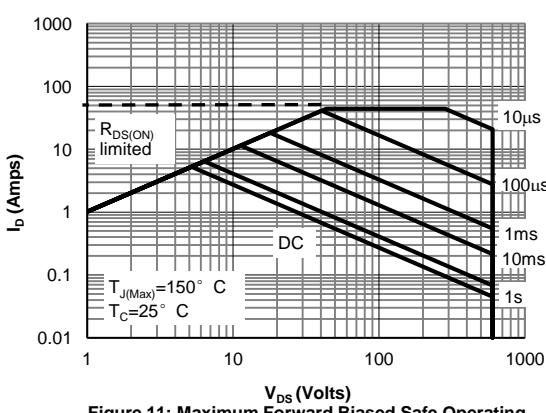
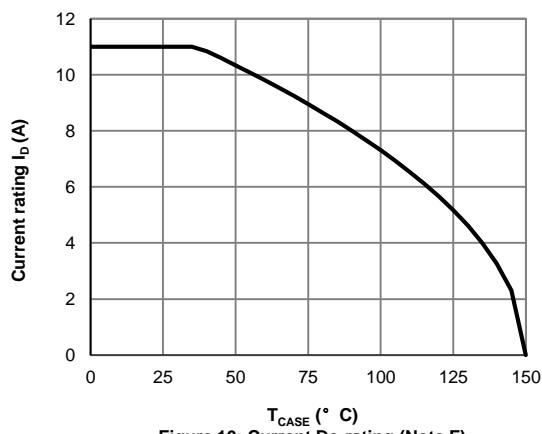
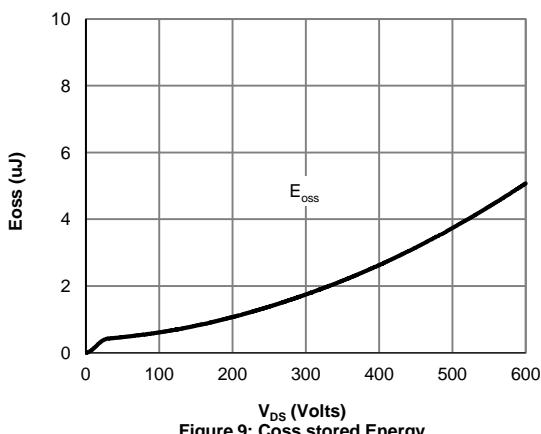


Figure 8: Capacitance Characteristics



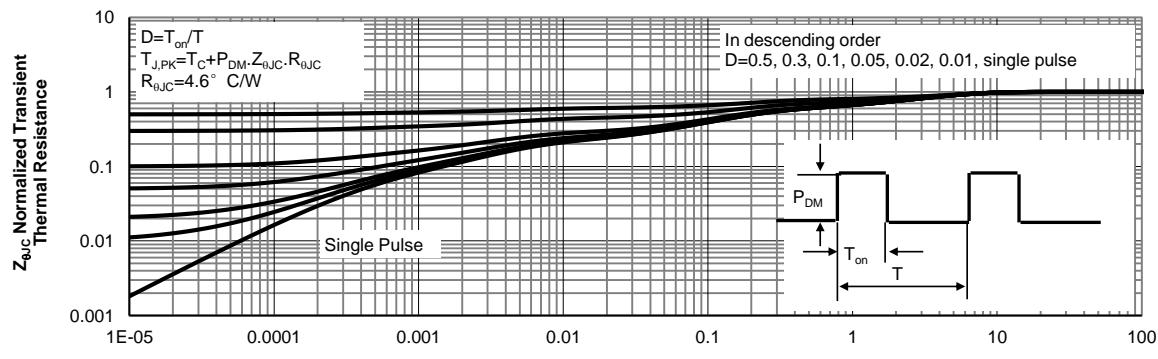
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure 13: Normalized Maximum Transient Thermal Impedance for AOTF380A60CL (Note F)

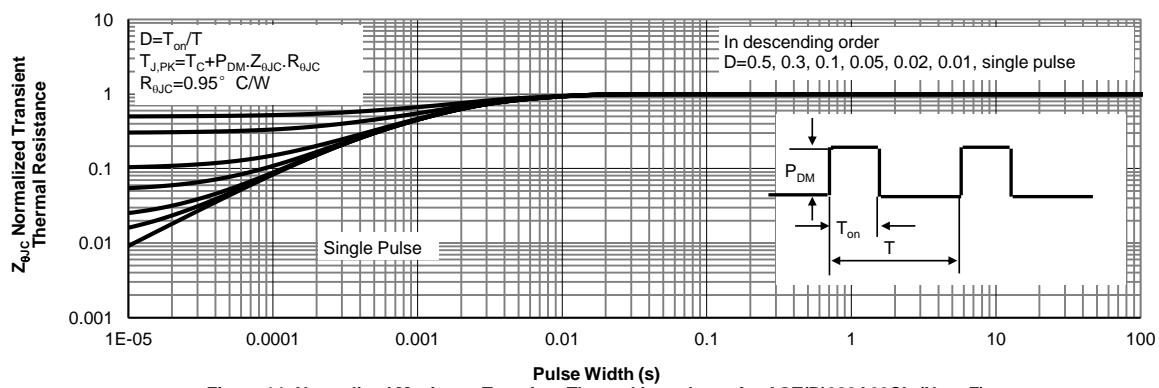
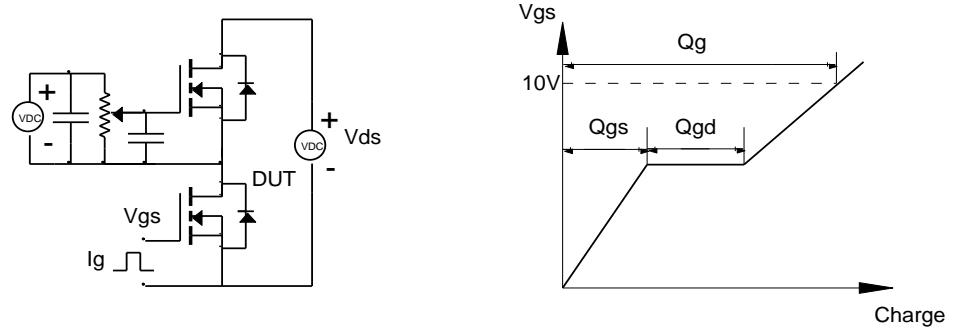
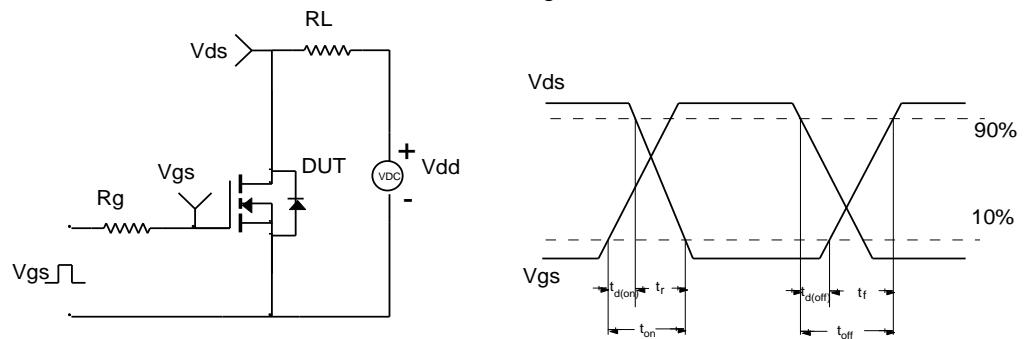
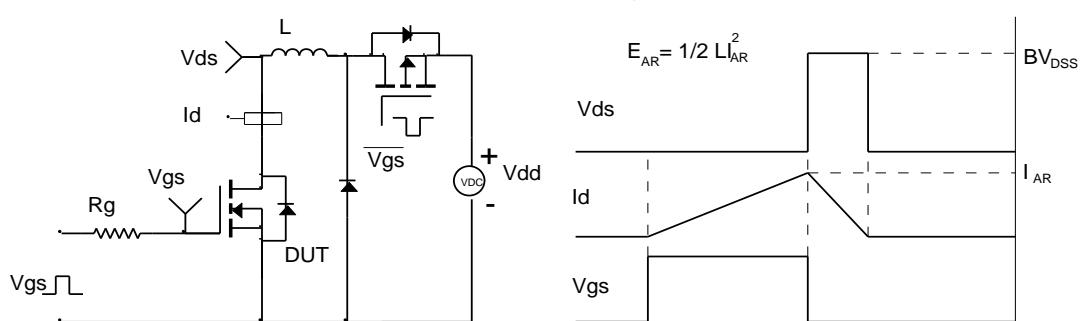
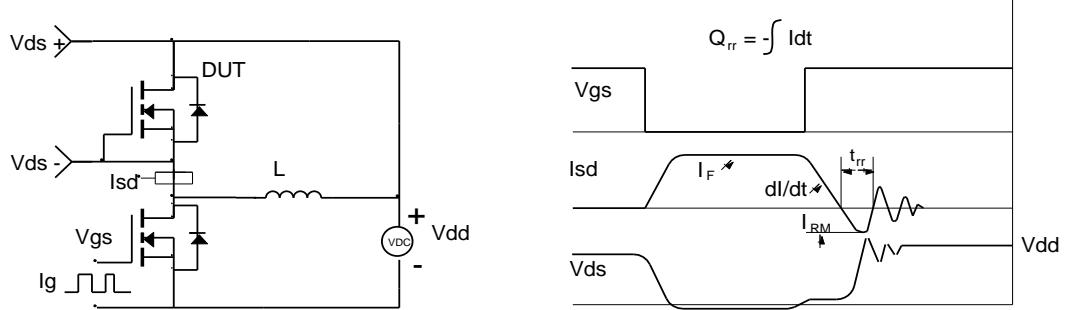


Figure 14: Normalized Maximum Transient Thermal Impedance for AOT(B)380A60CL (Note F)

Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

Diode Recovery Test Circuit & Waveforms




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